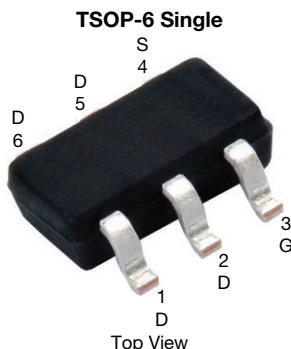


## P-Channel 20 V (D-S) MOSFET

| <b>PRODUCT SUMMARY</b>    |                                    |  |                             |
|---------------------------|------------------------------------|--|-----------------------------|
| <b>V<sub>DS</sub> (V)</b> | <b>R<sub>DS(on)</sub> (Ω) MAX.</b> | <b>I<sub>D</sub> (A) <sup>a, e</sup></b> | <b>Q<sub>g</sub> (TYP.)</b> |
| <b>-20</b>                | 0.047 at V <sub>GS</sub> = -4.5 V  | -4                                       | 9 nC                        |
|                           | 0.080 at V <sub>GS</sub> = -2.7 V  | -4                                       |                             |
|                           | 0.090 at V <sub>GS</sub> = -2.5 V  | -4                                       |                             |



### FEATURES

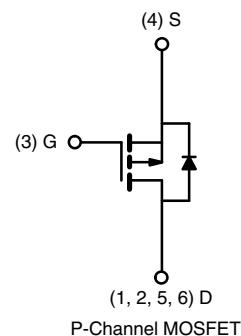
- TrenchFET® power MOSFET
- PWM optimized
- 100 % R<sub>g</sub> tested
- Material categorization:  
For definitions of compliance please see  
[www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
FREE

### APPLICATIONS

- Hard disk drives
- DC/DC converter
- Load switch
- Portable devices



**Marking Code:** BN

### Ordering Information:

Si3443DDV-T1-GE3 (Lead (Pb)-free and Halogen-free)

| <b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C, unless otherwise noted) |                                   |                 |      |
|--|-----------------------------------|-----------------|------|
| PARAMETER  | SYMBOL                            | LIMIT           | UNIT |
| Drain-Source Voltage   | V <sub>DS</sub>                   | -20             | V    |
| Gate-Source Voltage  | V <sub>GS</sub>                   | ± 12            | V    |
| Continuous Drain Current (T <sub>J</sub> = 150 °C)                               | T <sub>C</sub> = 25 °C            | -4 <sup>e</sup> | A    |
|  | T <sub>C</sub> = 70 °C            | -4 <sup>e</sup> |      |
|  | T <sub>A</sub> = 25 °C            | -4 b, c, e      |      |
|  | T <sub>A</sub> = 70 °C            | -3.9 b, c       |      |
| Pulsed Drain Current (t = 300 µs)  | I <sub>DM</sub>                   | -20             |      |
| Continuous Source-Drain Diode Current  | T <sub>C</sub> = 25 °C            | -2.25           | W    |
|  | T <sub>A</sub> = 25 °C            | -1.42 b, c      |      |
| Maximum Power Dissipation  | T <sub>C</sub> = 25 °C            | 2.7             | W    |
|  | T <sub>C</sub> = 70 °C            | 1.7             |      |
|  | T <sub>A</sub> = 25 °C            | 1.7 b, c        |      |
|  | T <sub>A</sub> = 70 °C            | 1.1 b, c        |      |
| Operating Junction and Storage Temperature Range                                 | T <sub>J</sub> , T <sub>stg</sub> | -55 to 150      | °C   |

| <b>THERMAL RESISTANCE RATINGS</b>           |              |                   |         |         |
|---|--------------|-------------------|---------|---------|
| PARAMETER                                   | SYMBOL       | TYPICAL           | MAXIMUM | UNIT    |
| Maximum Junction-to-Ambient <sup>b, d</sup> | t ≤ 5 s      | R <sub>thJA</sub> | 61      | 74      |
| Maximum Junction-to-Foot (Drain)            | Steady State | R <sub>thJF</sub> | 38      | 46 °C/W |

### Notes

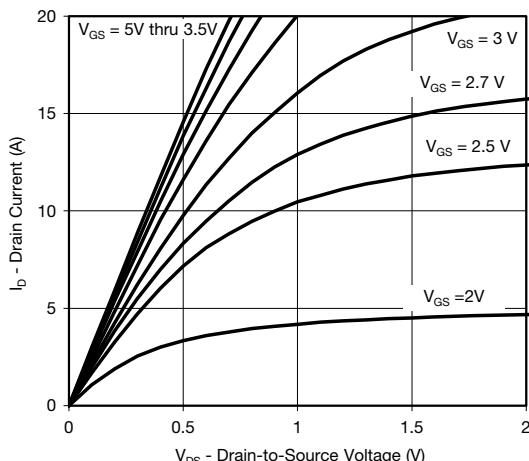
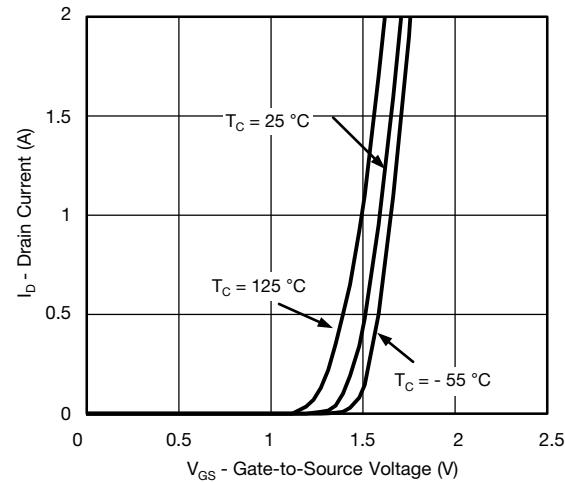
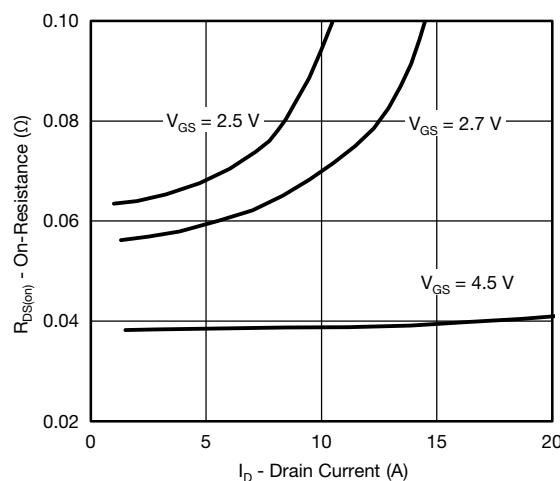
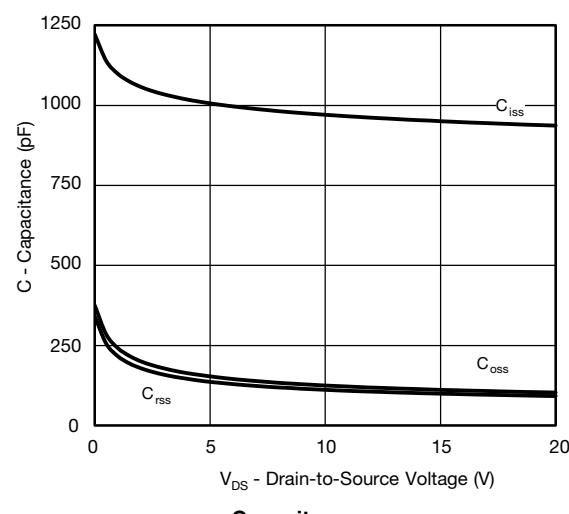
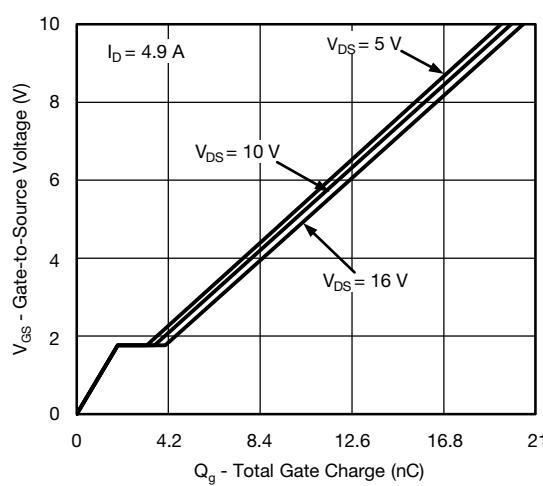
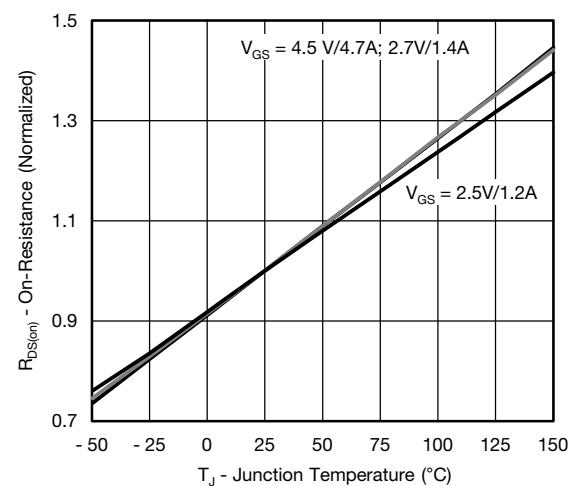
- Based on T<sub>C</sub> = 25 °C.
- Surface mounted on 1" x 1" FR4 board.
- t = 5 s.
- Maximum under steady state conditions is 120 °C/W.
- Package limited.

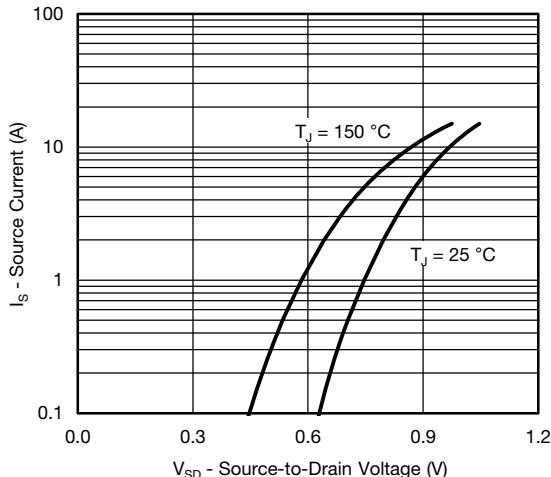
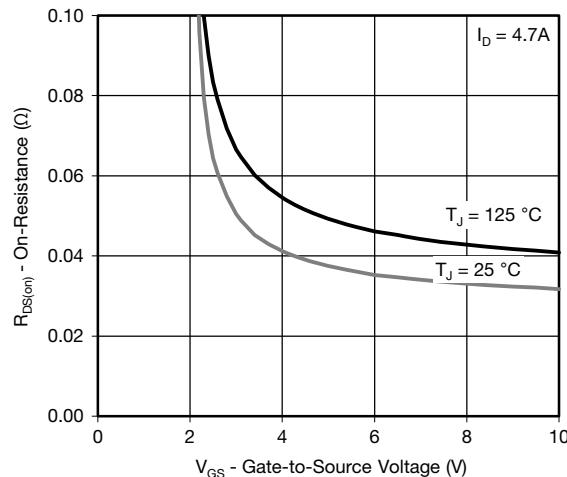
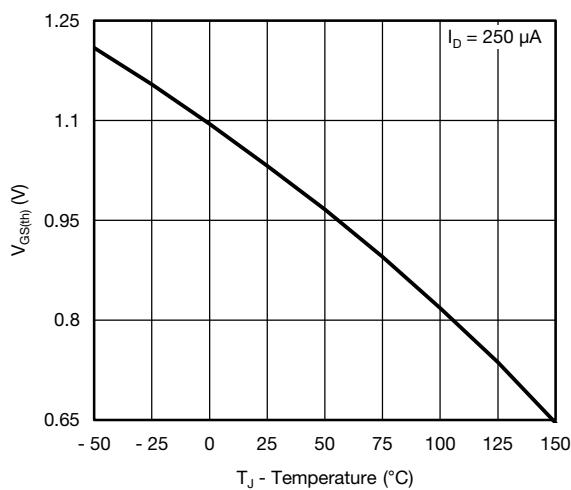
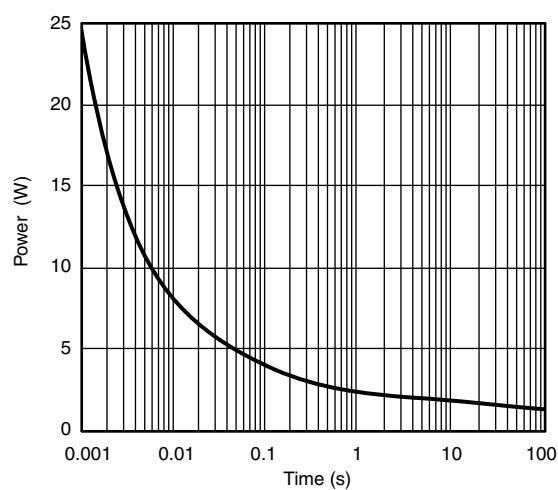
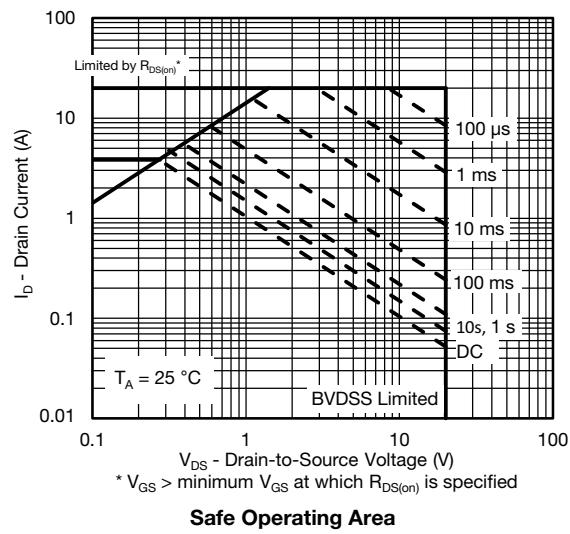
| <b>SPECIFICATIONS</b> ( $T_J = 25^\circ\text{C}$ , unless otherwise noted) |                                |  |      |       |           |                      |
|--|--------------------------------|--|------|-------|-----------|----------------------|
| PARAMETER  | SYMBOL                         | TEST CONDITIONS  | MIN. | TYP.  | MAX.      | UNIT                 |
| <b>Static</b>  |                                |  |      |       |           |                      |
| Drain-Source Breakdown Voltage   | $V_{DS}$                       | $V_{GS} = 0 \text{ V}$ , $I_D = -250 \mu\text{A}$  | -20  | -     | -         | V                    |
| $V_{DS}$ Temperature Coefficient   | $\Delta V_{DS}/T_J$            | $I_D = -250 \mu\text{A}$   | -    | -15   | -         | mV/ $^\circ\text{C}$ |
| $V_{GS(\text{th})}$ Temperature Coefficient                                | $\Delta V_{GS(\text{th})}/T_J$ |  | -    | 2.8   | -         |                      |
| Gate-Source Threshold Voltage  | $V_{GS(\text{th})}$            | $V_{DS} = V_{GS}$ , $I_D = -250 \mu\text{A}$   | -0.6 | -     | -1.5      | V                    |
| Gate-Source Leakage  | $I_{GSS}$                      | $V_{DS} = 0 \text{ V}$ , $V_{GS} = \pm 12 \text{ V}$   | -    | -     | $\pm 100$ | nA                   |
| Zero Gate Voltage Drain Current  | $I_{DSS}$                      | $V_{DS} = -20 \text{ V}$ , $V_{GS} = 0 \text{ V}$  | -    | -     | -1        | $\mu\text{A}$        |
|  |                                | $V_{DS} = -20 \text{ V}$ , $V_{GS} = 0 \text{ V}$ , $T_J = 55^\circ\text{C}$   | -    | -     | -10       |                      |
| On-State Drain Current <sup>a</sup>  | $I_{D(\text{on})}$             | $V_{DS} \geq -5 \text{ V}$ , $V_{GS} = -4.5 \text{ V}$   | -20  | -     | -         | A                    |
| Drain-Source On-State Resistance <sup>a</sup>                              | $R_{DS(\text{on})}$            | $V_{GS} = -4.5 \text{ V}$ , $I_D = -4.7 \text{ A}$   | -    | 0.039 | 0.047     | $\Omega$             |
|  |                                | $V_{GS} = -2.7 \text{ V}$ , $I_D = -1.4 \text{ A}$   | -    | 0.057 | 0.080     |                      |
|  |                                | $V_{GS} = -2.5 \text{ V}$ , $I_D = -1.2 \text{ A}$   | -    | 0.064 | 0.090     |                      |
| Forward Transconductance <sup>a</sup>                                      | $g_{fs}$                       | $V_{DS} = -10 \text{ V}$ , $I_D = -4.7 \text{ A}$  | -    | 14    | -         | S                    |
| <b>Dynamic <sup>b</sup></b>  |                                |  |      |       |           |                      |
| Input Capacitance  | $C_{iss}$                      | $V_{DS} = -10 \text{ V}$ , $V_{GS} = 0 \text{ V}$ , $f = 1 \text{ MHz}$  | -    | 970   | -         | pF                   |
| Output Capacitance   | $C_{oss}$                      |  | -    | 125   | -         |                      |
| Reverse Transfer Capacitance   | $C_{rss}$                      |  | -    | 111   | -         |                      |
| Total Gate Charge  | $Q_g$                          | $V_{DS} = -10 \text{ V}$ , $V_{GS} = -8 \text{ V}$ , $I_D = -4.9 \text{ A}$  | -    | 20    | 30        | nC                   |
| Gate-Source Charge   | $Q_{gs}$                       | $V_{DS} = -10 \text{ V}$ , $V_{GS} = -4.5 \text{ V}$ , $I_D = -4.9 \text{ A}$  | -    | 9     | 18        |                      |
| Gate-Drain Charge  | $Q_{gd}$                       |  | -    | 1.9   | -         |                      |
| Gate Resistance  | $R_g$                          |  | -    | 1.7   | -         |                      |
| Turn-On Delay Time   | $t_{d(on)}$                    | $V_{DD} = -10 \text{ V}$ , $R_L = 2.56 \Omega$<br>$I_D \approx -3.9 \text{ A}$ , $V_{GEN} = -4.5 \text{ V}$ , $R_g = 1 \Omega$ | -    | 27    | 41        | ns                   |
| Rise Time  | $t_r$                          |  | -    | 25    | 38        |                      |
| Turn-Off Delay Time  | $t_{d(off)}$                   |  | -    | 43    | 65        |                      |
| Fall Time  | $t_f$                          |  | -    | 18    | 27        |                      |
| <b>Drain-Source Body Diode Characteristics</b>                             |                                |  |      |       |           |                      |
| Continuous Source-Drain Diode Current                                      | $I_S$                          | $T_C = 25^\circ\text{C}$   | -    | -     | -2.25     | A                    |
| Pulse Diode Forward Current <sup>a</sup>                                   | $I_{SM}$                       |  | -    | -     | -20       |                      |
| Body Diode Voltage   | $V_{SD}$                       | $I_S = -3.9 \text{ A}$   | -    | -0.85 | -1.2      | V                    |
| Body Diode Reverse Recovery Time   | $t_{rr}$                       | $I_F = -3.9 \text{ A}$ , $dI/dt = 100 \text{ A}/\mu\text{s}$ , $T_J = 25^\circ\text{C}$  | -    | 11    | 20        | ns                   |
| Body Diode Reverse Recovery Charge   | $Q_{rr}$                       |  | -    | 3     | 6         |                      |
| Reverse Recovery Fall Time   | $t_a$                          |  | -    | 6     | -         | ns                   |
| Reverse Recovery Rise Time   | $t_b$                          |  | -    | 5     | -         |                      |

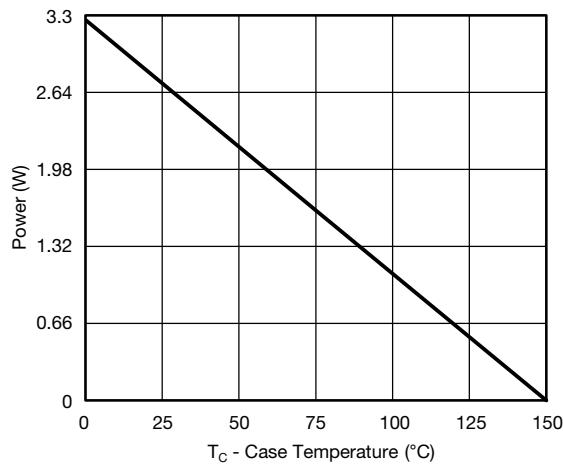
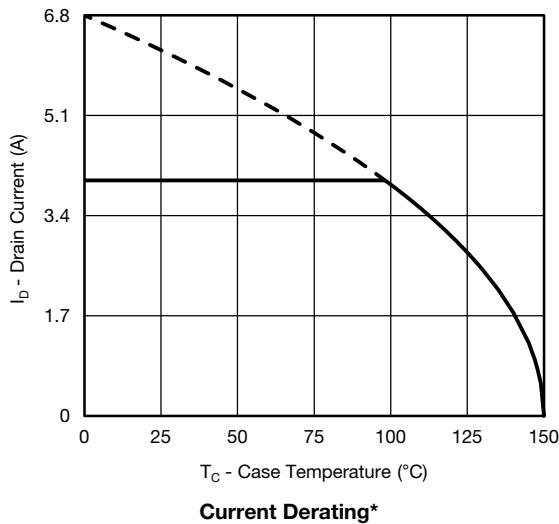
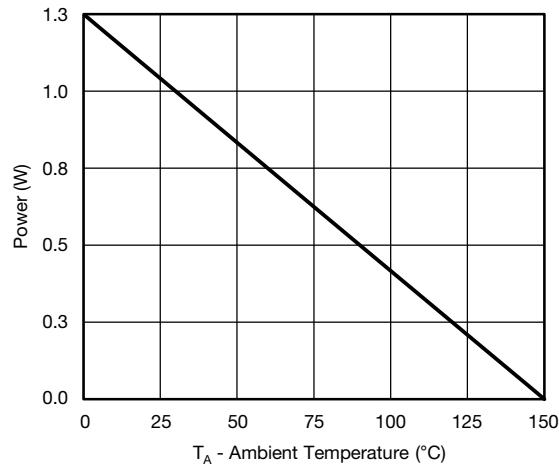
**Notes**

- a. Pulse test; pulse width  $\leq 300 \mu\text{s}$ , duty cycle  $\leq 2\%$ .
- b. Guaranteed by design, not subject to production testing.

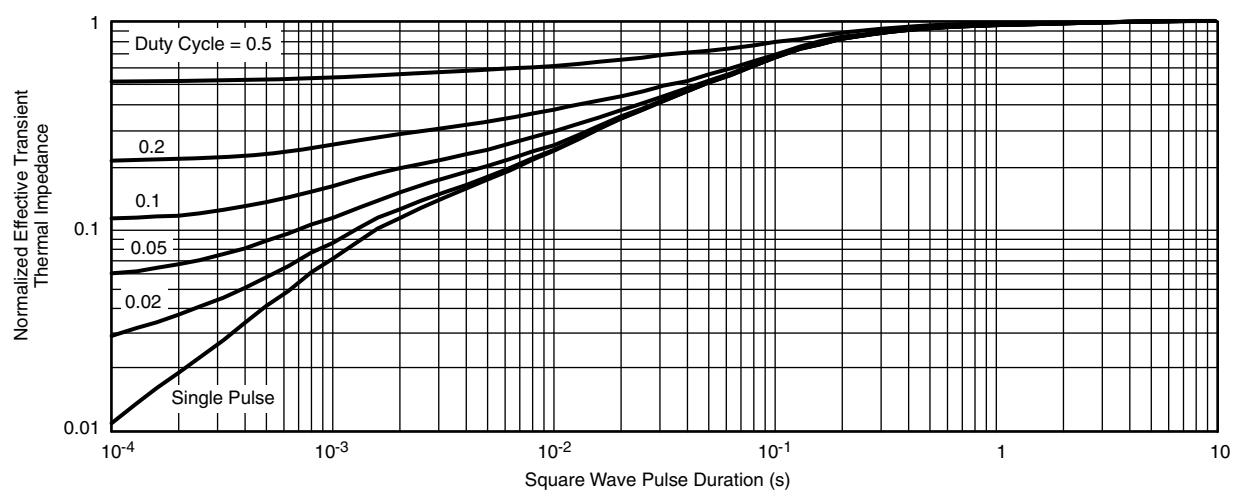
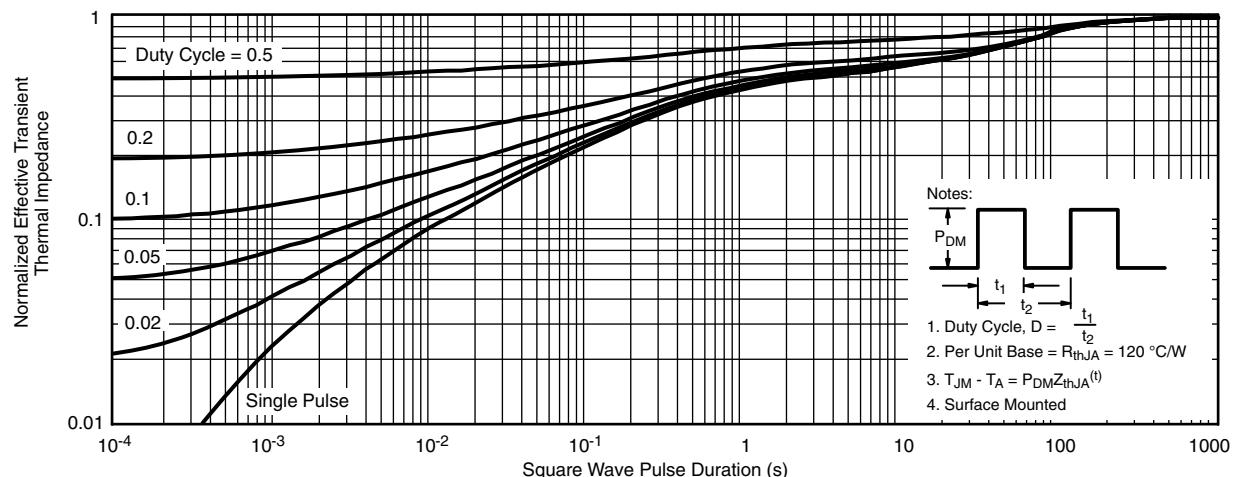
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)

**Output Characteristics**

**Transfer Characteristics**

**On-Resistance vs. Drain Current**

**Capacitance**

**Gate Charge**

**On-Resistance vs. Junction Temperature**

**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)

**Source-Drain Diode Forward Voltage**

**On-Resistance vs. Gate-to-Source Voltage**

**Threshold Voltage**

**Single Pulse Power, Junction-to-Ambient**

**Safe Operating Area**

**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)

**Power, Junction-to-Foot**

**Power, Junction-to-Ambient**

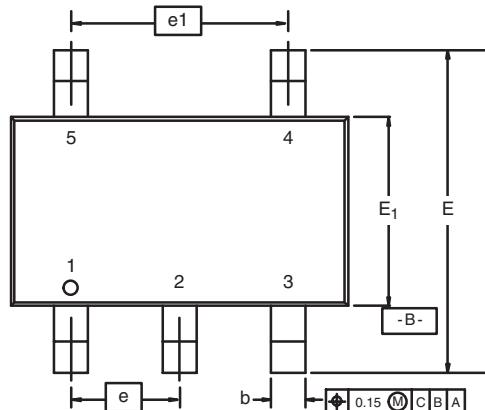
\* The power dissipation  $P_D$  is based on  $T_J(\max.) = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)


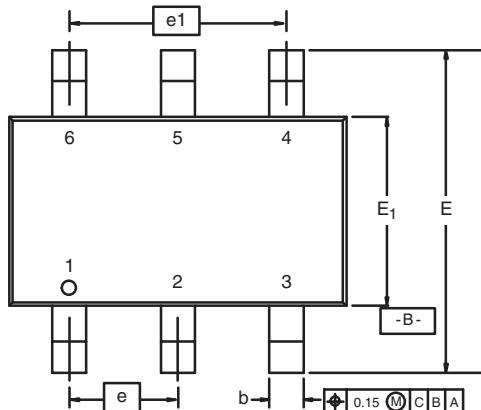
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see [www.vishay.com/ppg?62956](http://www.vishay.com/ppg?62956).

### TSOP: 5/6-LEAD

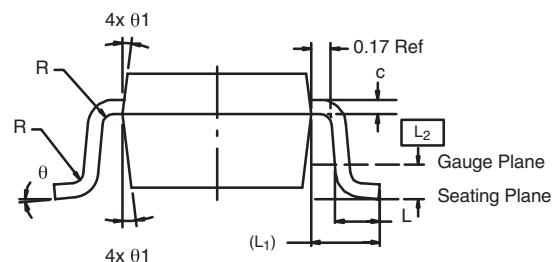
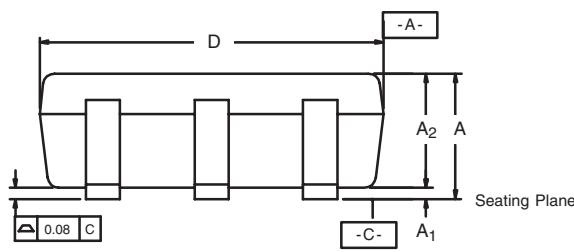
JEDEC Part Number: MO-193C



**5-LEAD TSOP**



**6-LEAD TSOP**

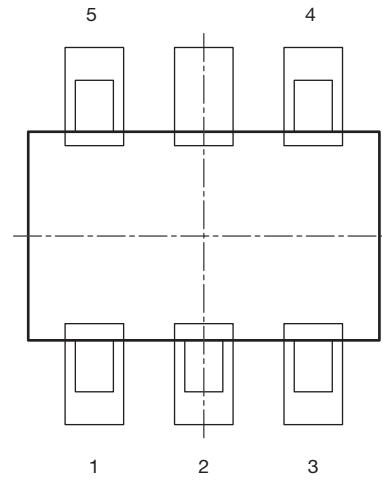


| Dim                  | MILLIMETERS |      |      | INCHES     |       |       |
|----------------------|-------------|------|------|------------|-------|-------|
|                      | Min         | Nom  | Max  | Min        | Nom   | Max   |
| <b>A</b>             | 0.91        | -    | 1.10 | 0.036      | -     | 0.043 |
| <b>A<sub>1</sub></b> | 0.01        | -    | 0.10 | 0.0004     | -     | 0.004 |
| <b>A<sub>2</sub></b> | 0.90        | -    | 1.00 | 0.035      | 0.038 | 0.039 |
| <b>b</b>             | 0.30        | 0.32 | 0.45 | 0.012      | 0.013 | 0.018 |
| <b>c</b>             | 0.10        | 0.15 | 0.20 | 0.004      | 0.006 | 0.008 |
| <b>D</b>             | 2.95        | 3.05 | 3.10 | 0.116      | 0.120 | 0.122 |
| <b>E</b>             | 2.70        | 2.85 | 2.98 | 0.106      | 0.112 | 0.117 |
| <b>E<sub>1</sub></b> | 1.55        | 1.65 | 1.70 | 0.061      | 0.065 | 0.067 |
| <b>e</b>             | 0.95 BSC    |      |      | 0.0374 BSC |       |       |
| <b>e<sub>1</sub></b> | 1.80        | 1.90 | 2.00 | 0.071      | 0.075 | 0.079 |
| <b>L</b>             | 0.32        | -    | 0.50 | 0.012      | -     | 0.020 |
| <b>L<sub>1</sub></b> | 0.60 Ref    |      |      | 0.024 Ref  |       |       |
| <b>L<sub>2</sub></b> | 0.25 BSC    |      |      | 0.010 BSC  |       |       |
| <b>R</b>             | 0.10        | -    | -    | 0.004      | -     | -     |
| <b>θ</b>             | 0°          | 4°   | 8°   | 0°         | 4°    | 8°    |
| <b>θ<sub>1</sub></b> | 7° Nom      |      |      | 7° Nom     |       |       |

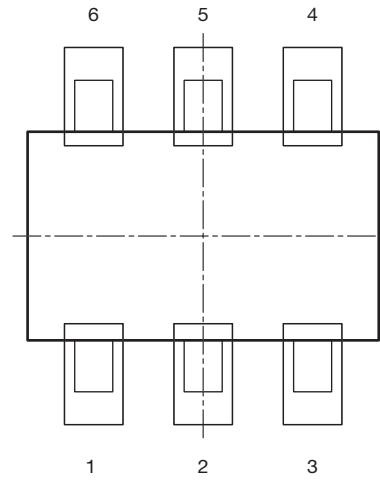
ECN: C-06593-Rev. I, 18-Dec-06

DWG: 5540

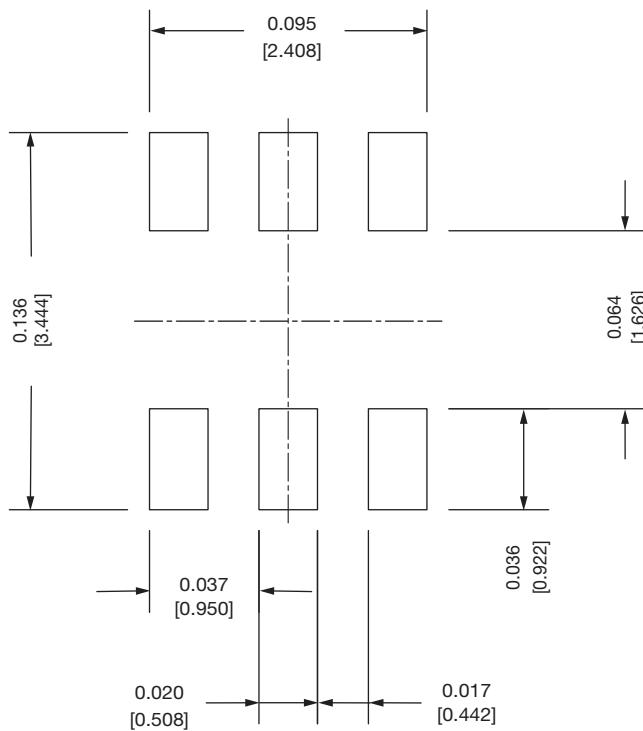
## Recommended Land Pattern For TSOP-5L / TSOP-6L



TSOP 5L



TSOP 6L


**Note**

- All dimensions are in inches (millimeter)

ECN: C22-0860-Rev. B, 24-Oct-2022  
DWG: 3010



## Disclaimer

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